502852817 06/16/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MAKOTO SORAOKA	02/28/2014

RECEIVING PARTY DATA

Name:	RENESAS ELECTRONICS CORPORATION
Street Address:	1753, SHIMONUMABE, NAKAHARA-KU
City:	KAWASAKI-SHI, KANAGAWA
State/Country:	JAPAN
Postal Code:	211-8668

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14303424

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	REN.161
NAME OF SUBMITTER:	SEAN M.MCGINN
SIGNATURE:	/Sean M.McGinn/
DATE SIGNED:	06/13/2014

Total Attachments: 4

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> PATENT REEL: 033108 FRAME: 0858

502852817

Docket No.: Only After Sept 16, 2012

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261) As the below named inventor, I hereby declare that: This assignment with declaration is The attached application, or directed to: United States Application or PCT International Application Number filed on The application is entitled: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE The above identified application was made or was authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted. I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. Authorization To Permit Access To Application by Participating Office If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application. In accordance with 37 OFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the aboveidentified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the aboveidentified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

PATENT REEL: 033108 FRAME: 0859

Legal Name of Inventor	Hiroshi FUJII				
Inventor's Signature Accorded Fugic		<u> Jac</u>	Date	March	5,2014
Legal Name of Additional Inventor, If Any Shigeki TANAKA		Shigeki TANAKA			
Inventor's Signature			Date_		
Legal Name of Additional Inventor, If Any		Kazuaki YOSHIDA			
Inventor's Signature			Date		

Docket No.: Only After Sept 16, 2012

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

Access to Application by Participating Office.

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

the assignee.	
(Legalization not required for recording	but is prima facie evidence of execution under 35 USC 261)
As the below named inventor, I hereby	declare that:
This assignment with declaration is directed to:	X The attached application, or
	United States Application or PCT International Application Number
	filed on
The application is entitled:	
	METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE
The above identified application was n	ade or was authorized to be made by me.
I believe that I am the original invento	or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the c	ntents of the application for which this assignment with declaration is being submitted.
I am aware of the duty to disclose to	ne Office all information known to me to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful or imprisonment of not more than five	lise statement made in this assignment with declaration is punishable under 18 USC 1001 by fine (5) years, or both.
Authorization To Permit Access To	pplication by Participating Office
(JPO), the Korean Intellectual Property property offices in which a foreign app patent application. See 37 CFR 1.14(c	r grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual ication claiming priority to the above-identified application is filed access to the above-identified and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or ch a foreign application claiming priority to the above-identified application is filed to have
identified patent application-as-filed, 119(a)-(d) if a copy of the foreign app	access will be provided to a copy of the application—as—filed with respect to: 1) the above—) any foreign application to which the above—identified application claims priority under 35 USC cation that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above— v U.S. application—as—filed from which benefit is sought in the above—identified patent application.
In accordance with 37 CFR 1.14(c), ac	cess may be provided to information concerning the date of filing the Authorization to Permit

PATENT REEL: 033108 FRAME: 0861

Legal Name of Inventor	Hiroshi FUJII			
Inventor's Signature			Date	
Legal Name of Additional I	nventor, If Any	Shigeki TANAKA		
Inventor's Signature	<u>Shiqeki</u>	Tomaka	Date	Hebruarg-24, 2014
Legal Name of Additional-li	nventor, If Any	Kazuaki YÖSHIDA		
Inventor's Signature	Kazunli	Mashida	Date	February 17, 2014

PATENT 2 of 2 **REEL: 033108 FRAME: 0862**